

## **Product Change Notification**

Date January 5, 2024

Product

Digi ConnectCore MP1 SOMs and DVKs

## Reason for Change:

Technical Requirement	Product Transition
Customer Requirement	Product Discontinuation
Quality Improvement	Product Enhancement
Change of Production Location	Other

Audience	Channel Partners and Direct Customers
Description of Change	The recommended dimensions of the cutout required in a carrier board PCB to populate the ConnectCore MP15 and ConnectCore MP13 System-on-Modules (SOM) have been increased.
	This has been done to increase the spacing between components on the bottom side of the SOM and the cutout edge allowing for more tolerances when populating the SOM on a carrier board during manufacturing.
	The cutout has been increased by 0.4mm in every direction. This leaves 0.31mm between copper and cutout edge which is sufficient for most PCB manufacturers who are typically defining 0.25mm as the smallest accepted spacing for standard PCB technology grade.
	Customers that have been manufacturing devices with the previously defined cutout dimensions, and have not seen any manufacturing issues, can continue to use the previously defined cutout.
	<ul> <li>Both Altium Designer PCB SOM footprints have been updated on our Support Site:</li> <li><u>Digi ConnectCore MP15</u></li> <li><u>Digi ConnectCore MP13</u></li> </ul>

Affected	Digi ConnectCore MP157:
Part	CC-WST-DW69-NM
Numbers	CC-ST-DW69-ZM
	CC-WMP157-KIT
	Digi ConnectCore MP133:
	CC-WST-DX58-NK
	CC-ST-DX58-ZK
	CC-WMP133-KIT



Timing of Change	Effectivity: January 2024
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Authorization	Digi International Embedded Product Management